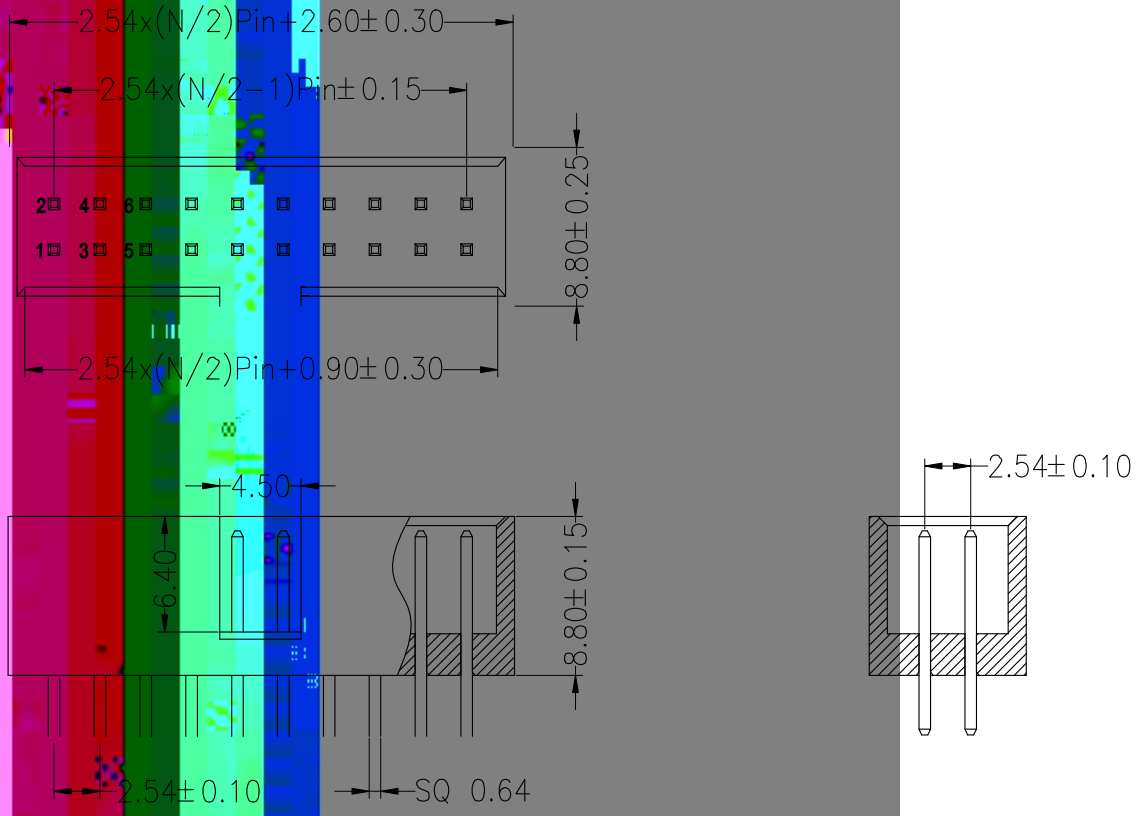
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Resistance To Soldering Heat:
245° C±5° C, 10s(PBT insulator)
260° C±5° C, 10s(PA6T&PA9T&LCP insulator)



Ordering Information

3213 XX S XX X B K00 X 0X

- XX: Contact Plating
  - G0:Gold Flash
  - G1:1u" Gold
  - G2:1.5u" Gold
  - G3:2u" Gold
  - G4:3u" Gold
  - G5:5u" Gold
  - G6:10u" Gold
  - G7:15u" Gold
  - G8:30u" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- X: Insulator Material Option
  - C=BK−PA6T
  - E=I

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2022.07.01	NEW DRAWING	

OPERATION		DRAW	Jelly Feng 22.07.01
X.X	±0.30		
X.XX	±0.20	CHECK	
X.XXX	±0.10		
Angle	±3°	APPROVE	
DIM	TOL		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

PART NO.	3213XXSXXXBK00X0X
TITLE:	2.54mm Box Header H8.8mm 180° 短体